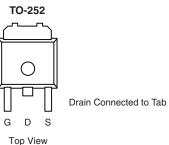


Vishay Siliconix

N-Channel 60 V (D-S), MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)	
60	0.031 at V _{GS} = 10 V	9.1	6.5 nC	
00	0.045 at V _{GS} = 4.5 V	7.6	0.5 110	



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested •
- Compliant to RoHS Directive 2002/95/EC

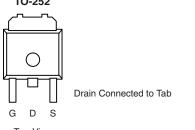
GC

APPLICATIONS

DC/DC Converters



RoHS COMPLIANT HALOGEN FREE



Ordering Information: SUD23N06-31-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

D

ABSOLUTE MAXIMUM RATINGS	S (T _A = 25 °C, unles	ss otherwise n	oted)	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	60	v
Gate-Source Voltage		V _{GS}	± 20	
	T _C = 25 °C		21.4	
Continuous Drain Current (T. -150 °C)	T _C = 70 °C	1	17.1	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	Ι _D	9.1 ^a	
	T _A = 70 °C		7.6 ^a	А
Pulsed Drain Current		I _{DM}	50	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	20.8	
	T _A = 25 °C		3.8 ^a	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20	
Avalanche Energy	L = 0.1 min	E _{AS}	20	mJ
	T _C = 25 °C	- P _D	31.25	
	T _C = 70 °C		20	w
Maximum Power Dissipation	T _A = 25 °C		5.7 ^a	vv
	T _A = 70 °C		3.6 ^a	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \le 10 s$	R _{thJA}	18	22	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	3.2	4.0	0/10

Notes:

a. Surface mounted on 1" x 1" FR4 board, t \leq 10 s.

SUD23N06-31

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 14		65		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6.3			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.0		3.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$			20		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50			Α	
Drain Course On State Desistance		V _{GS} = 10 V, I _D = 15 A		0.025	0.031	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A		0.037	0.045		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		20		S	
Dynamic ^b		·					
Input Capacitance	C _{iss}			670			
Output Capacitance	C _{oss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		140		pF	
Reverse Transfer Capacitance	C _{rss}			60			
Total Cata Charge	0	$V_{DS} = 30$ V, $V_{GS} = 10$ V, $I_{D} = 23$ A		11	17	nC	
Total Gate Charge	Qg			6.5	13		
Gate-Source Charge	Q _{gs}	$V_{DS} = 30$ V, $V_{GS} = 4.5$ V, $I_{D} = 23$ A		3.0			
Gate-Drain Charge	Q _{gd}			3.0			
Gate Resistance	Rg	f = 1 MHz		1.6	3.2	Ω	
Turn-On Delay Time	t _{d(on)}			18	30	_	
Rise Time	t _r	V_{DD} = 30 V, R_L = 1.3 Ω		250	400		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 23$ A, V_{GEN} = 4.5 V, R_g = 1 Ω		35	55		
Fall Time	t _f			68	110		
Turn-On Delay Time	t _{d(on)}			8	15	ns	
Rise Time	t _r	V_{DD} = 30 V, R_L = 1.3 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 23 A, V_GEN = 10 V, R_g = 1 Ω		30	45		
Fall Time	t _f			25	40		
Drain-Source Body Diode Characteris	tics						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			20.8	^	
Pulse Diode Forward Current ^a	I _{SM}	1			50	- A	
Body Diode Voltage	V _{SD}	I _S = 15 A		1.0	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			30	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			35	70	nC	
Reverse Recovery Fall Time	ta	l _F = 15 A, dl/dt = 100 A/μs, T _J = 25 °C		20			
Reverse Recovery Rise Time	t _b			10		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

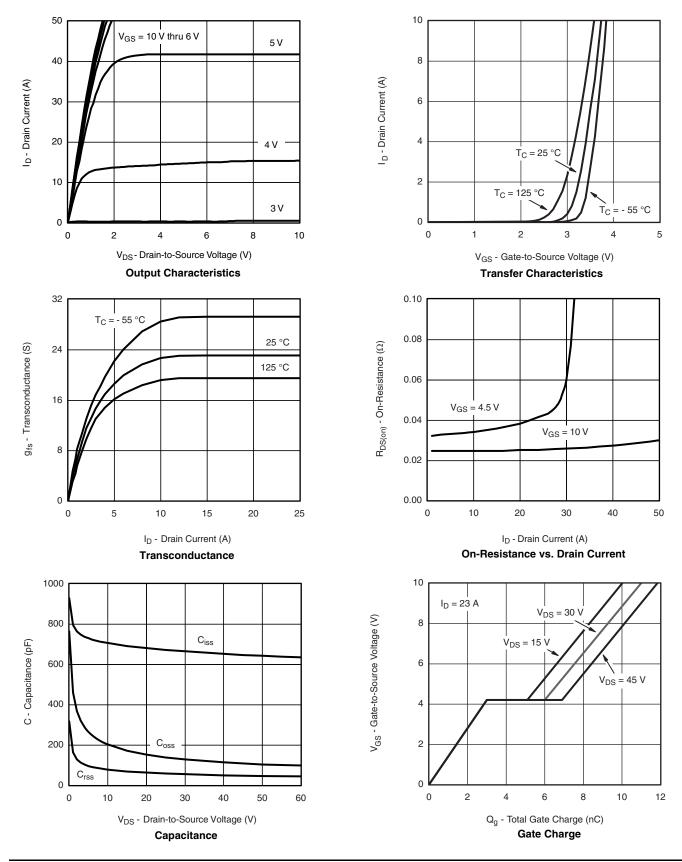
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



SUD23N06-31 Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



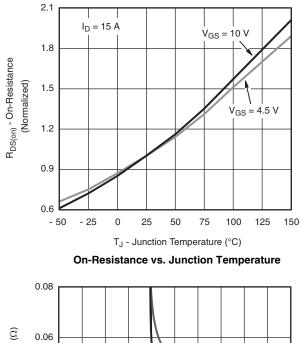
Document Number: 68857 S11-0181-Rev. B, 07-Feb-11

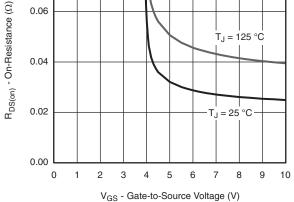
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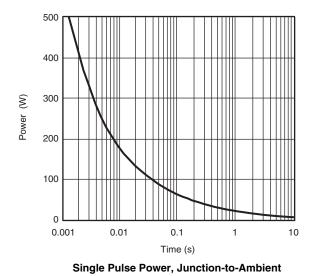
Vishay Siliconix

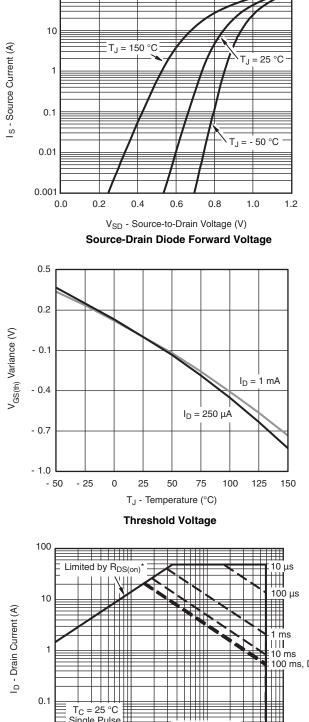
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



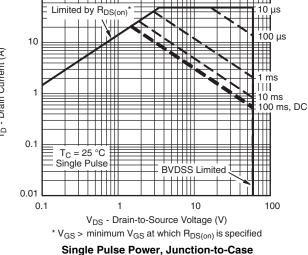








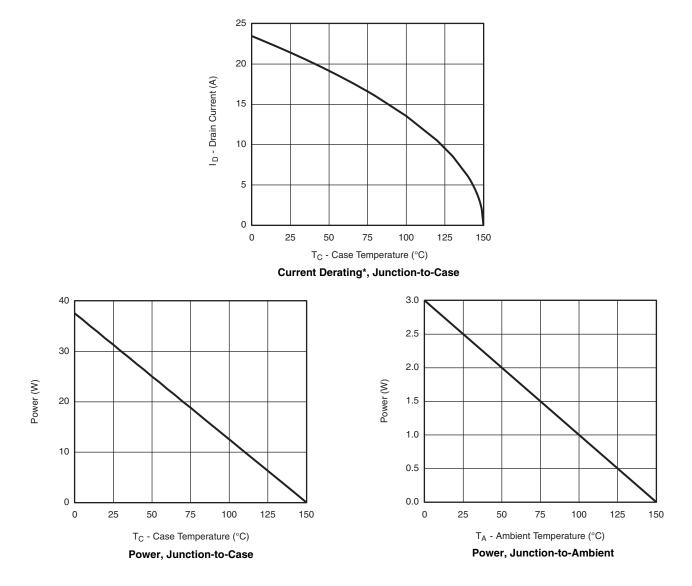
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SUD23N06-31 Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

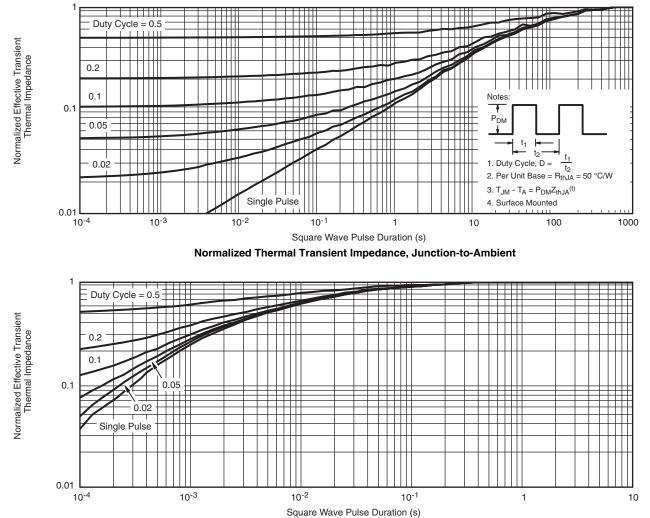


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg268857.

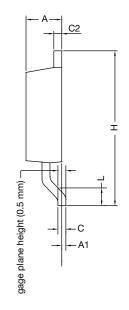


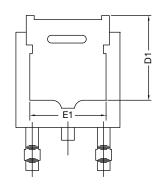


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

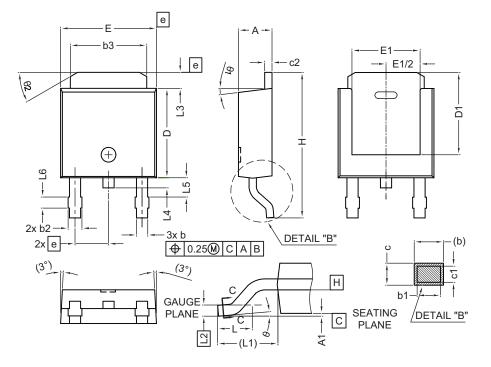
Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	l ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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Vishay

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